BYT54M

SINTERED GLASS JUNCTION FAST AVALANCHE RECTIFIER

VOLTAGE: 1000V CURRENT: 1.25A



FEATURE

Glass passivated Hermetically sealed package Low reverse current Soft recovery characteristics

MECHANICAL DATA

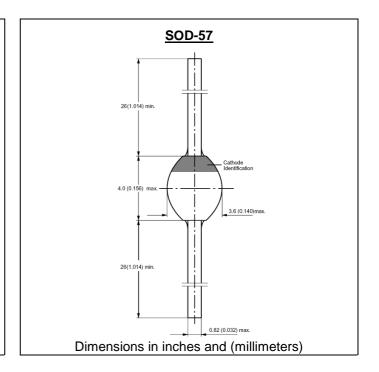
Case: SOD-57 sintered glass case

Terminal: Plated axial leads solderable per

MIL-STD 202E, method 208C

Polarity: color band denotes cathode end

Mounting position: any



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

	SYMBOL	BYT54M	units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	1000	V
Maximum RMS Voltage	V _{RMS}	700	V
Maximum DC blocking Voltage	V _{DC}	1000	V
Maximum Average Forward Rectified Current 3/8"lead length at I =10mm	I _{FAV}	1.25	А
Peak Forward Surge Current at tp=10ms,half sinewave	I _{FSM}	30	А
Maximum Forward Voltage at rated Forward Current at IF=1.0A	V _F	1.5	V
Non-repetitive peak reverse avalanche energy at I _{BR(R)} =0.4A	E _{RSM}	10	mJ
Maximum DC Reverse Current $Ta = 25^{\circ}C$ at rated DC blocking voltage $Ta = 150^{\circ}C$	I _R	5.0 150.0	μA μA
Maximum Reverse Recovery Time (Note 1)	Trr	100	nS
Typical Thermal Resistance (Note 2)	R _{th(ja)}	100	°C /W
Storage and Operating Junction Temperature	Tstg, Tj	-65 to +175	°C

Note:

- 1. Reverse Recovery Condition If =0.5A, Ir =1.0A, Irr =0.25A
- 2. on PC board with spacing 25 mm

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RATINGS AND CHARACTERISTIC CURVES BYT54M

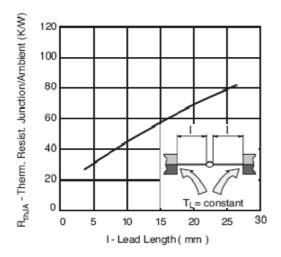


Figure 1. Max. Thermal Resistance vs. Lead Length

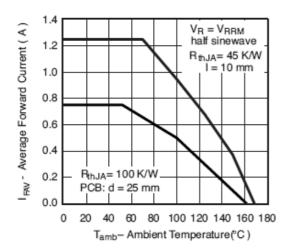


Figure 3. Max. Average Forward Current vs. Ambient Temperature

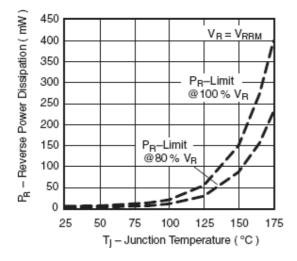


Figure 5. Max. Reverse Power Dissipation vs. Junction Temperature

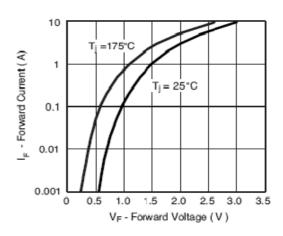


Figure 2. Forward Current vs. Forward Voltage

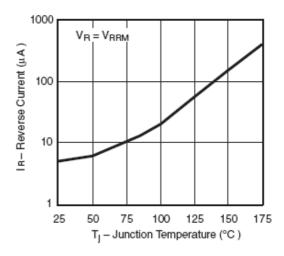


Figure 4. Reverse Current vs. Junction Temperature

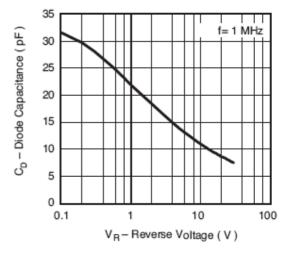


Figure 6. Diode Capacitance vs. Reverse Voltage

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